SHIGA7,033APC PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Hada et al.

Appl. No. : 10/557,694

Filed: November 22, 2005

For : RESIN FOR PHOTORESIST

COMPOSITION, PHOTORESIST COMPOSITION AND METHOD

FOR FORMING RESIST PATTERN

Examiner : Kelly, C.

Group Art Unit : 1752

## PRELIMINARY AMENDMENT

## Mail Stop Amendment

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Preliminary to examination on the merits, please amend the above-captioned U.S. National Phase Application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 7 of this paper.